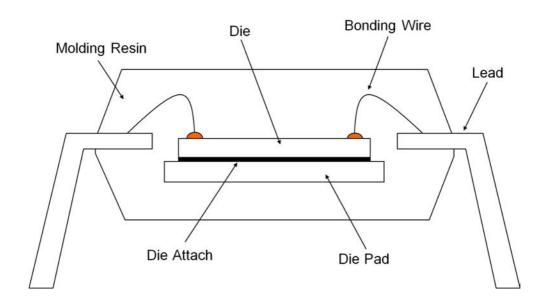


Package Information: DIP8K

1. Package Information

Package Name DIP8K
Type DIP
Pin Count 8
Package Weight [g] 0.5
Lead Finish Pure Tin
MSL Level -

2. Package Structure



3. Packing Specification

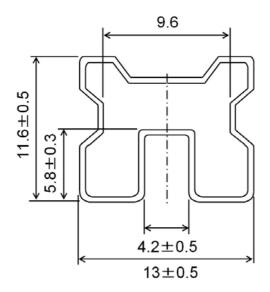
3.1 Packing form, Quantity

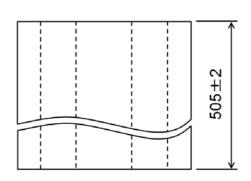
Packing Form Tube
Packing Quantity [pcs] 50

3.2 Use material

Item	Material
Tube	PC
Stopper	TPE
Unit box	Cardboard
Shipping box	Cardboard

3.3 Tube Specification 3.3.1 Tube Dimension

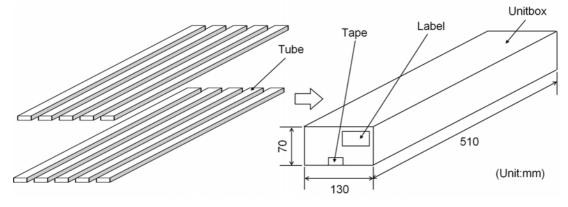




(unit:mm)

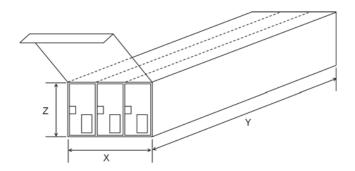
3.4 Packing Method

40 tube(s) or less per unit box



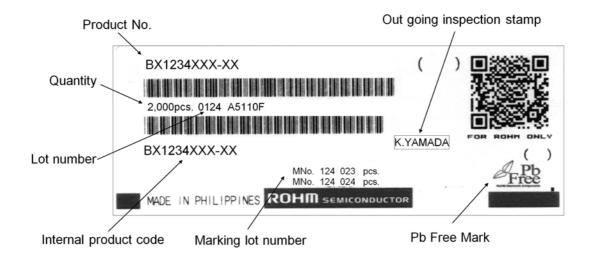
3.9 Packing Style

3 unit boxes or less per shipping box

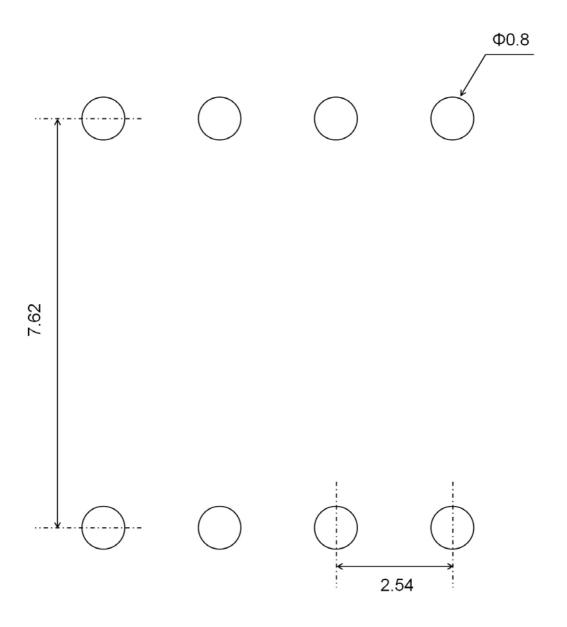


	(unit:mm)		
Shipping Box Dimension				
X	230			
Υ	579			
Z	136			

3.10 Label Specification



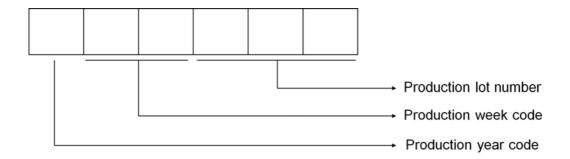
4. Footprint dimensions



(unit:mm)

In actual design, please optimize in accordance with the situation of your board design and soldering condition.

5. Marking Specification



6. Storage conditions

6.1 Storage environment

Recommended storage conditions

	Min.	Max.	Unit
Temperature	5	30	°C
Humidity	40	70	% RH

6.2 Storage period

	Min.	Max.	Unit
Storage period	-	1	year

7. Soldering conditions

7.1 Recommended condition for wave soldering

Preheating temperature : 120 °C to 150 °C

Preheating time : 60 s MAX

Soldering temperature : 260 $^{\circ}$ C \pm 3 $^{\circ}$ C

Soldering time : 12 s MAX

Notes for wave soldering

- (1) Soldering time is provided for total soldering time in case of dual wave soldering.
- (2) Do not use other soldering methods with wave soldering.
- (3) Recommend to clean the board to eliminate flux, solder waste, and other impurities for reliability, after soldering.
- (4) Optimize soldering condition to prevent solder bridging.

7.2 Recommended condition for solder iron

Solder iron temperature : 380 °C or less Mounting time : 4 s or less

Notes

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- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
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- 9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
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- 11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
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